- **3-State Outputs Drive Bus Lines or Buffer Memory Address Registers**
- **pnp Inputs Reduce dc Loading**
- **Package Options Include Plastic Small-Outline (DW) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs**
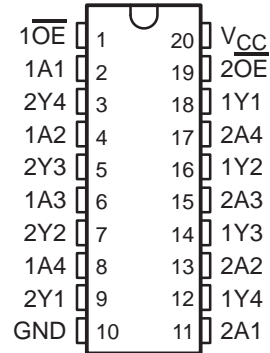
description

These octal buffers and line drivers are designed specifically to improve the performance and density of 3-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. With the ′ALS240A, ′ALS241C, ′AS240A, and′AS241A, these devices provide the choice of selected combinations of inverting outputs, symmetrical active-low output-enable ($\overline{OE}$) inputs, and complementary OE and $\overline{OE}$ inputs.
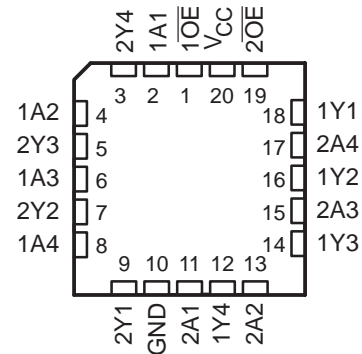
The -1 version of SN74ALS244C is identical to the standard version, except that the recommended maximum I_{OL} for the -1 version is 48 mA. There is no -1 version of the SN54ALS244C.

The SN54ALS244C and SN54AS244A are characterized for operation over the full military temperature range of −55°C to 125°C. The SN74ALS244C and SN74AS244A are characterized for operation from 0°C to 70°C.

SN54ALS244C, SN54AS244A . . . J PACKAGE
SN74ALS244C, SN74AS244A . . . DW OR N PACKAGE
(TOP VIEW)

1$\overline{OE}$	1		20	V$_{CC}$
1A1	2		19	2$\overline{OE}$
2Y4	3		18	1Y1
1A2	4		17	2A4
2Y3	5		16	1Y2
1A3	6		15	2A3
2Y2	7		14	1Y3
1A4	8		13	2A2
2Y1	9		12	1Y4
GND	10		11	2A1

SN54ALS244C, SN54AS244A . . . FK PACKAGE
(TOP VIEW)

Top pins (left to right): 2Y4, 1A1, 1$\overline{OE}$, V$_{CC}$, 2$\overline{OE}$
Pin numbers top: 3, 2, 1, 20, 19

Left side:
1A2	4
2Y3	5
1A3	6
2Y2	7
1A4	8

Right side:
18	1Y1
17	2A4
16	1Y2
15	2A3
14	1Y3

Bottom pins: 9, 10, 11, 12, 13
Bottom labels: 2Y1, GND, 2A1, 1Y4, 2A2

FUNCTION TABLE
(each buffer)

INPUTS		OUTPUT
$\overline{OE}$	A	Y
L	H	H
L	L	L
H	X	Z

TEXAS INSTRUMENTS

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SN54ALS244C, SN54AS244A, SN74ALS244C, SN74AS244A
OCTAL BUFFERS AND LINE DRIVERS
WITH 3-STATE OUTPUTS

logic symbol†

logic diagram (positive logic)
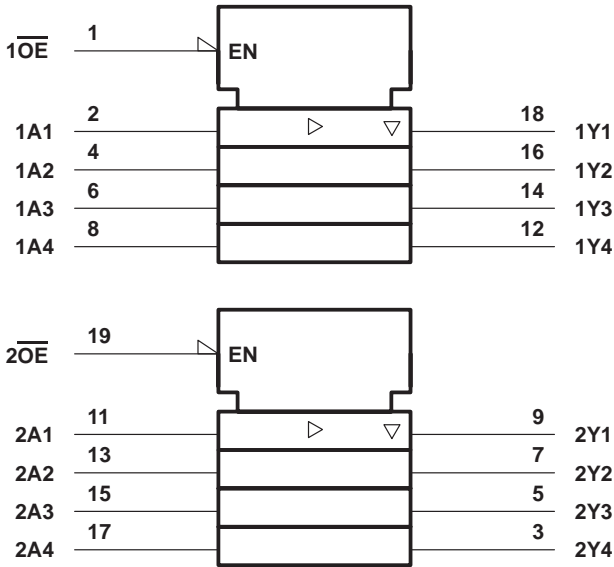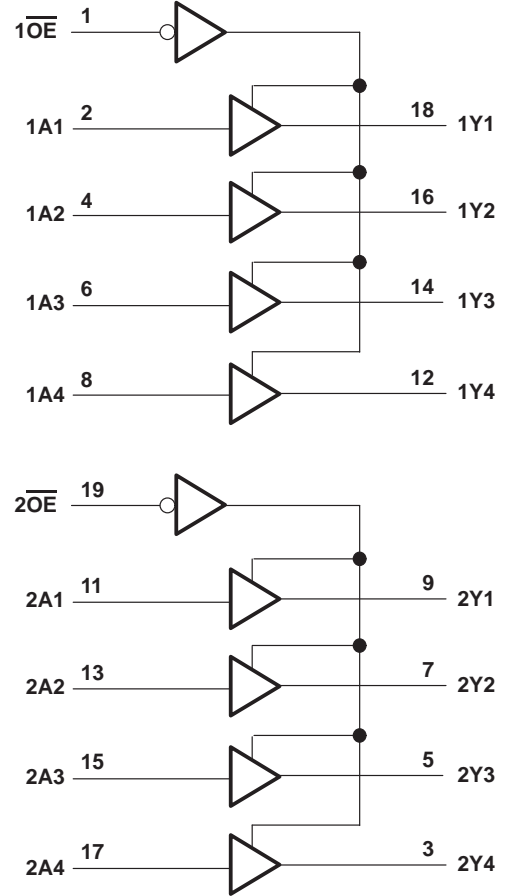
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and
IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V_{CC} .... 7 V
Input voltage, V_I .... 7 V
Voltage applied to a disabled 3-state output .... 5.5 V
Operating free-air temperature range, T_A: SN54ALS244C .... −55°C to 125°C
SN74ALS244C .... 0°C to 70°C
Storage temperature range .... −65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and
functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not
implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

TEXAS
INSTRUMENTS

recommended operating conditions

		SN54ALS244C			SN74ALS244C			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8†			0.8	V
				0.7‡				
I_{OH}	High-level output current			−12			−15	mA
I_{OL}	Low-level output current			12			24	mA
							48§	
T_A	Operating free-air temperature	−55		125	0		70	°C

† Applies over temperature range −55°C to 70°C
‡ Applies over temperature range 70°C to 125°C
§ Applies only to the -1 version and only if V_{CC} is between 4.75 V and 5.25 V

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		SN54ALS244C			SN74ALS244C			UNIT
			MIN	TYP¶	MAX	MIN	TYP¶	MAX	
V_{IK}	V_{CC} = 4.5 V,	I_I = −18 mA			−1.5			−1.5	V
V_{OH}	V_{CC} = 4.5 V to 5.5 V	I_{OH} = −0.4 mA	V_{CC}−2			V_{CC}−2			V
		I_{OH} = −3 mA	2.4	3.2		2.4	3.2		
	V_{CC} = 4.5 V	I_{OH} = −12 mA	2						
		I_{OH} = −15 mA				2			
V_{OL}	V_{CC} = 4.5 V	I_{OL} = 12 mA		0.25	0.4		0.25	0.4	V
		I_{OL} = 24 mA					0.35	0.5	
		I_{OL} = 48 mA (-1 version)					0.35	0.5	
I_{OZH}	V_{CC} = 5.5 V,	V_O = 2.7 V			20			20	µA
I_{OZL}	V_{CC} = 5.5 V,	V_O = 0.4 V			−20			−20	µA
I_I	V_{CC} = 5.5 V,	V_I = 7 V			0.1			0.1	mA
I_{IH}	V_{CC} = 5.5 V,	V_I = 2.7 V			20			20	µA
I_{IL}	V_{CC} = 5.5 V,	V_I = 0.4 V			−0.1			−0.1	mA
I_O#	V_{CC} = 5.5 V,	V_O = 2.25 V	−20		−112	−30		−112	mA
I_{CC}	V_{CC} = 5.5 V	Outputs high		9	18		9	17	mA
		Outputs low		15	25		15	24	
		Outputs disabled		17	29		17	27	

¶ All typical values are at V_{CC} = 5 V, T_A = 25°C.
# The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V_{CC} = 4.5 V to 5.5 V, C_L = 50 pF, R1 = 500 Ω, R2 = 500 Ω, T_A = MIN to MAX†				UNIT
			SN54ALS244C		SN74ALS244C		
			MIN	MAX	MIN	MAX	
t_{PLH}	A	Y	1	16	2	10	ns
t_{PHL}			3	12	3	10	
t_{PZH}	$\overline{OE}$	Y	1	26	3	20	ns
t_{PZL}			1	24	3	20	
t_{PHZ}	$\overline{OE}$	Y	2	10	2	10	ns
t_{PLZ}			1	26	1	13	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V_{CC} . . . . 7 V
Input voltage, V_I . . . . 7 V
Voltage applied to a disabled 3-state output . . . . 5.5 V
Operating free-air temperature range, T_A: SN54AS244A . . . . −55°C to 125°C
SN74AS244A . . . . 0°C to 70°C
Storage temperature range . . . . −65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and
functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not
implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		SN54AS244A			SN74AS244A			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	
V_{CC}	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
V_{IH}	High-level input voltage	2			2			V
V_{IL}	Low-level input voltage			0.8			0.8	V
I_{OH}	High-level output current			−12			−15	mA
I_{OL}	Low-level output current			48			64	mA
T_A	Operating free-air temperature	−55		125	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54AS244A			SN74AS244A			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
V_{IK}		$V_{CC} = 4.5$ V,	$I_I = -18$ mA			-1.2			-1.2	V
V_{OH}		$V_{CC} = 4.5$ V to 5.5 V,	$I_{OH} = -2$ mA	$V_{CC} - 2$			$V_{CC} - 2$			V
		$V_{CC} = 4.5$ V	$I_{OH} = -3$ mA	2.4	3.4		2.4	3.4		
			$I_{OH} = -12$ mA	2.4						
			$I_{OH} = -15$ mA				2.4			
V_{OL}		$V_{CC} = 4.5$ V	$I_{OL} = 48$ mA			0.55				V
			$I_{OL} = 64$ mA						0.55	
I_{OZH}		$V_{CC} = 5.5$ V,	$V_O = 2.7$ V			50			50	μA
I_{OZL}		$V_{CC} = 5.5$ V,	$V_O = 0.4$ V			-50			-50	μA
I_I		$V_{CC} = 5.5$ V,	$V_I = 7$ V			0.1			0.1	mA
I_{IH}		$V_{CC} = 5.5$ V,	$V_I = 2.7$ V			20			20	μA
I_{IL}	$\overline{OE}$	$V_{CC} = 5.5$ V,	$V_I = 0.4$ V			-0.5			-0.5	mA
	A					-1			-1	
I_O‡		$V_{CC} = 5.5$ V,	$V_O = 2.25$ V	-50		-150	-50		-150	mA
I_{CC}		$V_{CC} = 5.5$ V	Outputs high		22	34		22	34	mA
			Outputs low		60	90		60	90	
			Outputs disabled		34	54		34	54	

† All typical values are at $V_{CC} = 5$ V, $T_A = 25°C$.
‡ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS}.

switching characteristics (see Figure 1)

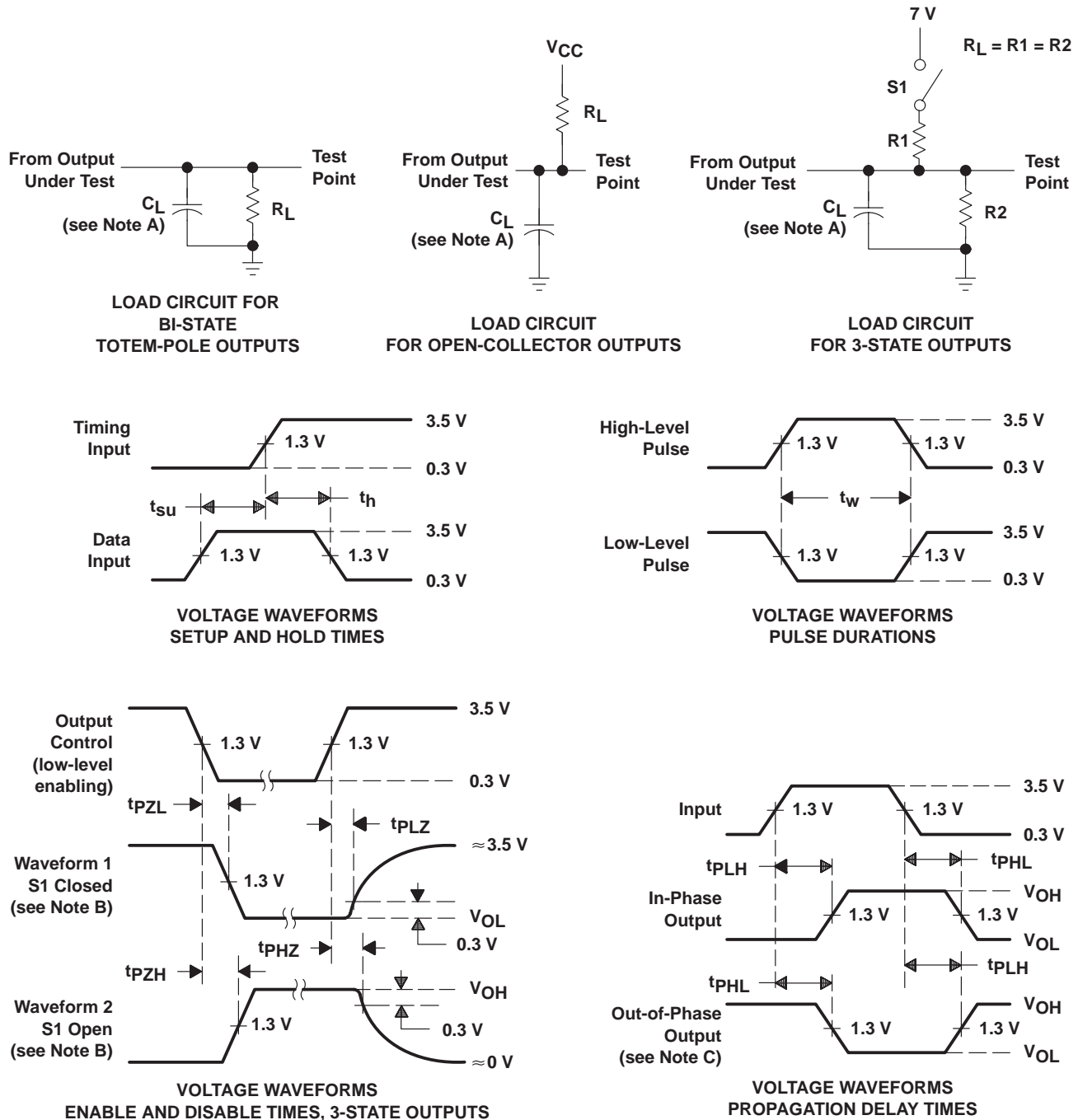| PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC} = 4.5$ V to 5.5 V, $C_L = 50$ pF, R1 = 500 Ω, R2 = 500 Ω, T_A = MIN to MAX§				UNIT
			SN54AS244A		SN74AS244A		
			MIN	MAX	MIN	MAX	
t_{PLH}	A	Y	2	9	2	6.2	ns
t_{PHL}			1	7	1	6.2	
t_{PZH}	$\overline{OE}$	Y	1	10	1	9	ns
t_{PZL}			2	8	2	7.5	
t_{PHZ}	$\overline{OE}$	Y	1	6.5	1	6	ns
t_{PLZ}			1	10.5	1	9	

§ For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

PARAMETER MEASUREMENT INFORMATION
SERIES 54ALS/74ALS AND 54AS/74AS DEVICES

**LOAD CIRCUIT FOR
BI-STATE
TOTEM-POLE OUTPUTS**

**LOAD CIRCUIT
FOR OPEN-COLLECTOR OUTPUTS**

$R_L = R1 = R2$

**LOAD CIRCUIT
FOR 3-STATE OUTPUTS**

**VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES**

**VOLTAGE WAVEFORMS
PULSE DURATIONS**

**VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES, 3-STATE OUTPUTS**

**VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES**

NOTES: A. C_L includes probe and jig capacitance.
   B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
      Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
   C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
   D. All input pulses have the following characteristics: PRR ≤ 1 MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
   E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

![Texas Instruments logo]

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
5962-86839012A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-86839012A SNJ54ALS 244CFK	Samples
5962-8683901RA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-8683901RA SNJ54ALS244CJ	Samples
5962-8683901SA	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-8683901SA SNJ54ALS244CW	Samples
5962-8683901VRA	ACTIVE	CDIP	J	20	20	TBD	A42	N / A for Pkg Type	-55 to 125	5962-8683901VRA SNV54ALS244CJ	Samples
5962-8683901VSA	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-8683901VSA SNV54ALS244CW	Samples
5962-9755901QRA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-9755901QRA SNJ54AS244AJ	Samples
JM38510/38303B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/38303B2A	Samples
JM38510/38303BRA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/38303BRA	Samples
M38510/38303B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	JM38510/38303B2A	Samples
M38510/38303BRA	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	JM38510/38303BRA	Samples
SN54ALS244CJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54ALS244CJ	Samples
SN54AS244AJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	SN54AS244AJ	Samples
SN74ALS244C-1DW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS244C-1	Samples
SN74ALS244C-1DWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS244C-1	Samples
SN74ALS244C-1N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS244C-1N	Samples

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74ALS244C-1NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS244C-1	Samples
SN74ALS244CDBR	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	G244C	Samples
SN74ALS244CDBRG4	ACTIVE	SSOP	DB	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	G244C	Samples
SN74ALS244CDW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS244C	Samples
SN74ALS244CDWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS244C	Samples
SN74ALS244CN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74ALS244CN	Samples
SN74ALS244CNSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	ALS244C	Samples
SN74AS244ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	AS244A	Samples
SN74AS244ADWR	ACTIVE	SOIC	DW	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	AS244A	Samples
SN74AS244AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74AS244AN	Samples
SN74AS244ANE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	0 to 70	SN74AS244AN	Samples
SN74AS244ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	0 to 70	74AS244A	Samples
SNJ54ALS244CFK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type	-55 to 125	5962-86839012A SNJ54ALS 244CFK	Samples
SNJ54ALS244CJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-8683901RA SNJ54ALS244CJ	Samples
SNJ54ALS244CW	ACTIVE	CFP	W	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-8683901SA SNJ54ALS244CW	Samples
SNJ54AS244AJ	ACTIVE	CDIP	J	20	1	TBD	A42	N / A for Pkg Type	-55 to 125	5962-9755901QR A SNJ54AS244AJ	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

[2] **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

[3] MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

[4] There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

[5] Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

[6] Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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OTHER QUALIFIED VERSIONS OF SN54ALS244C, SN54ALS244C-SP, SN54AS244A, SN74ALS244C, SN74AS244A :

● Catalog: SN74ALS244C, SN54ALS244C, SN74AS244A

● Military: SN54ALS244C, SN54AS244A

● Space: SN54ALS244C-SP

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product

- Military - QML certified for Military and Defense Applications

- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

PACKAGE MATERIALS INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS244C-1DWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74ALS244C-1NSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1
SN74ALS244CDBR	SSOP	DB	20	2000	330.0	16.4	8.2	7.5	2.5	12.0	16.0	Q1
SN74ALS244CDWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74ALS244CNSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1
SN74AS244ADWR	SOIC	DW	20	2000	330.0	24.4	10.8	13.3	2.7	12.0	24.0	Q1
SN74AS244ANSR	SO	NS	20	2000	330.0	24.4	8.4	13.0	2.5	12.0	24.0	Q1

PACKAGE MATERIALS INFORMATION

TAPE AND REEL BOX DIMENSIONS

*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS244C-1DWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74ALS244C-1NSR	SO	NS	20	2000	367.0	367.0	45.0
SN74ALS244CDBR	SSOP	DB	20	2000	367.0	367.0	38.0
SN74ALS244CDWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74ALS244CNSR	SO	NS	20	2000	367.0	367.0	45.0
SN74AS244ADWR	SOIC	DW	20	2000	367.0	367.0	45.0
SN74AS244ANSR	SO	NS	20	2000	367.0	367.0	45.0

N (R−PDIP−T**)   PLASTIC DUAL−IN−LINE PACKAGE
16 PINS SHOWN

DIM \ PINS **	14	16	18	20
A MAX	0.775 (19,69)	0.775 (19,69)	0.920 (23,37)	1.060 (26,92)
A MIN	0.745 (18,92)	0.745 (18,92)	0.850 (21,59)	0.940 (23,88)
C MS−001 VARIATION	AA	BB	AC	AD

A

16   9

0.260 (6,60)
0.240 (6,10)

1   8

0.070 (1,78)
0.045 (1,14) D

0.045 (1,14) D
0.030 (0,76)

0.020 (0,51) MIN

0.325 (8,26)
0.300 (7,62)

0.015 (0,38)

Gauge Plane

0.200 (5,08) MAX

Seating Plane

0.010 (0,25) NOM

0.125 (3,18) MIN

0.100 (2,54)

0.430 (10,92) MAX

0.021 (0,53)
0.015 (0,38)

⊕ 0.010 (0,25) Ⓜ

14/18 Pin Only
20 Pin vendor option D

4040049/E 12/2002

NOTES: A.   All linear dimensions are in inches (millimeters).
         B.   This drawing is subject to change without notice.
         C.   Falls within JEDEC MS−001, except 18 and 20 pin minimum body length (Dim A).
         D.   The 20 pin end lead shoulder width is a vendor option, either half or full width.

10.63
9.97 TYP

A

PIN 1 ID
AREA

1

18X 1.27

20

C

SEATING PLANE

0.1 C

13.0
12.6
NOTE 3

2X
11.43

10

11

B

7.6
7.4
NOTE 4

20X 0.51
0.31

2.65 MAX

0.25 C A B

SEE DETAIL A

0.33 TYP
0.10

0.25
GAGE PLANE

0° - 8°

1.27
0.40

0.3
0.1

DETAIL A
TYPICAL
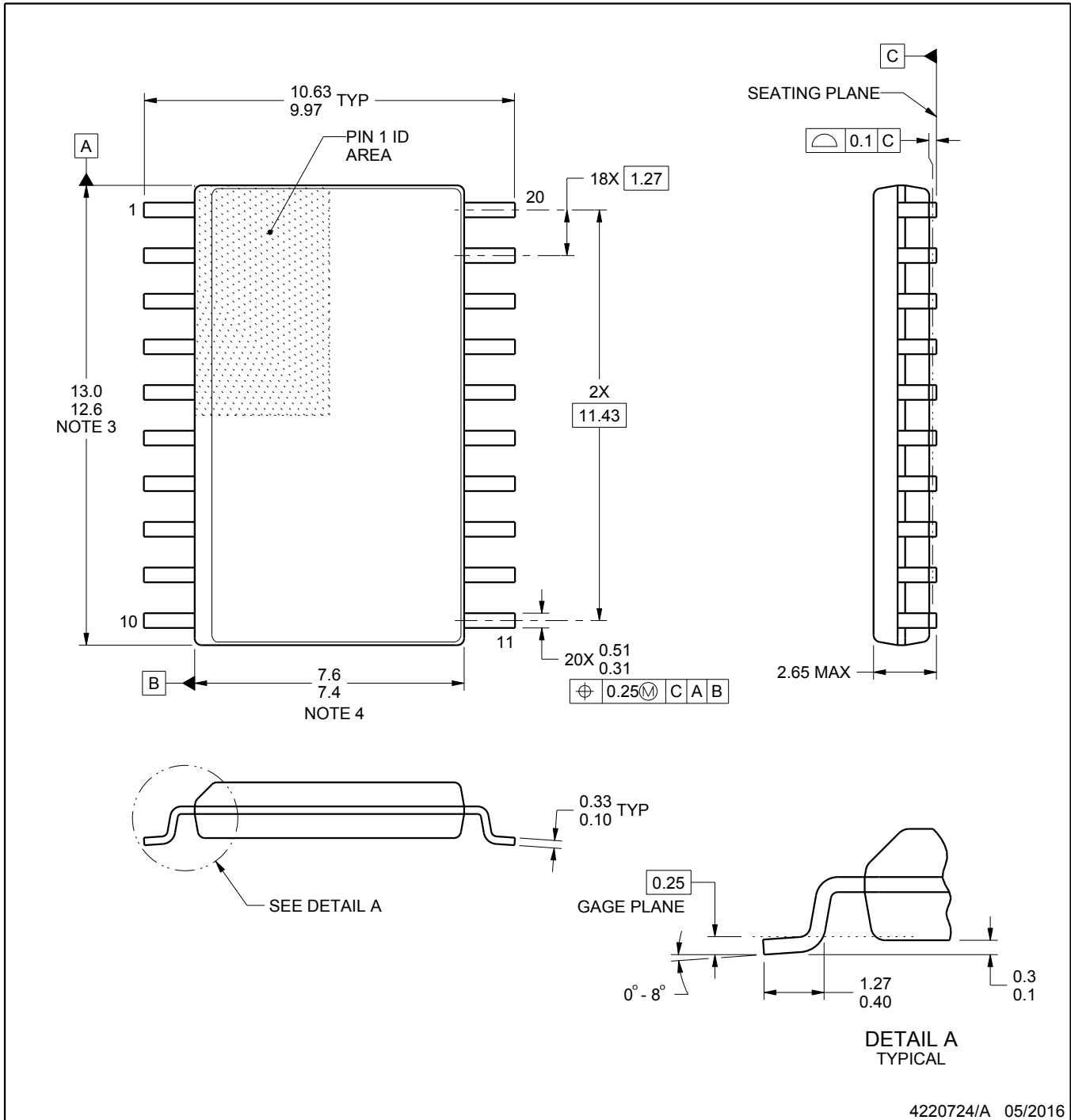
4220724/A 05/2016

NOTES:

1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
   per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
   exceed 0.15 mm per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.43 mm per side.
5. Reference JEDEC registration MS-013.

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20X (2)

SYMM

1

20

20X (0.6)

18X (1.27)

SYMM

(R0.05)
TYP

10

11

(9.3)

LAND PATTERN EXAMPLE
SCALE:6X

SOLDER MASK
OPENING

METAL

METAL UNDER
SOLDER MASK

SOLDER MASK
OPENING

0.07 MAX
ALL AROUND

0.07 MIN
ALL AROUND

NON SOLDER MASK
DEFINED

SOLDER MASK
DEFINED

SOLDER MASK DETAILS

4220724/A   05/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

**TEXAS
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20X (2)

1

20X (0.6)

18X (1.27)

SYMM
℄

SYMM
℄

20

10

11

(9.3)
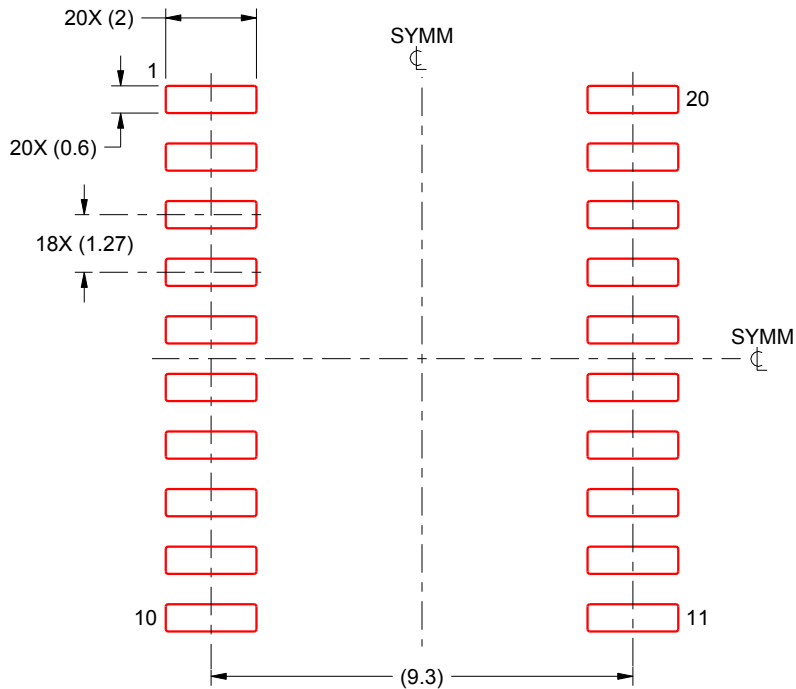
SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4220724/A   05/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate
design recommendations.
9. Board assembly site may have different recommendations for stencil design.

W (R−GDFP−F20)   CERAMIC DUAL FLATPACK

Base and Seating Plane

0.045 (1,14)
─────────────
0.026 (0,66)

0.300 (7,62)
─────────────
0.245 (6,22)

0.009 (0,23)
─────────────
0.004 (0,10)

0.100 (2,45)
─────────────
0.045 (1,14)

0.320 (8,13) MAX

1   20

0.022 (0,56)
─────────────
0.015 (0,38)

0.050 (1,27)

0.540 (13,72) MAX

0.005 (0,13) MIN
4 Places

10   11

0.370 (9,40)
─────────────
0.250 (6,35)

0.370 (9,40)
─────────────
0.250 (6,35)

4040180−4/F 04/14

NOTES: A.   All linear dimensions are in inches (millimeters).
         B.   This drawing is subject to change without notice.
         C.   This package can be hermetically sealed with a ceramic lid using glass frit.
         D.   Index point is provided on cap for terminal identification only.
         E.   Falls within Mil−Std 1835 GDFP2−F20

FK (S−CQCC−N**)
28 TERMINAL SHOWN

LEADLESS CERAMIC CHIP CARRIER

NO. OF TERMINALS **	A		B	
	MIN	MAX	MIN	MAX
20	0.342 (8,69)	0.358 (9,09)	0.307 (7,80)	0.358 (9,09)
28	0.442 (11,23)	0.458 (11,63)	0.406 (10,31)	0.458 (11,63)
44	0.640 (16,26)	0.660 (16,76)	0.495 (12,58)	0.560 (14,22)
52	0.740 (18,78)	0.761 (19,32)	0.495 (12,58)	0.560 (14,22)
68	0.938 (23,83)	0.962 (24,43)	0.850 (21,6)	0.858 (21,8)
84	1.141 (28,99)	1.165 (29,59)	1.047 (26,6)	1.063 (27,0)

4040140/D 01/11

NOTES: A.   All linear dimensions are in inches (millimeters).
   B.   This drawing is subject to change without notice.
   C.   This package can be hermetically sealed with a metal lid.
   D.   Falls within JEDEC MS−004

MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN

DIM \ PINS **	14	16	20	24
A MAX	10,50	10,50	12,90	15,30
A MIN	9,90	9,90	12,30	14,70

4040062/C 03/03

NOTES: A.   All linear dimensions are in millimeters.
         B.   This drawing is subject to change without notice.
         C.   Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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DIM / PINS **	14	16	18	20
A	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC	0.300 (7,62) BSC
B MAX	0.785 (19,94)	.840 (21,34)	0.960 (24,38)	1.060 (26,92)
B MIN	——	——	——	——
C MAX	0.300 (7,62)	0.300 (7,62)	0.310 (7,87)	0.300 (7,62)
C MIN	0.245 (6,22)	0.245 (6,22)	0.220 (5,59)	0.245 (6,22)

B

14   8

C

1   7

$\dfrac{0.065\ (1,65)}{0.045\ (1,14)}$

0.005 (0,13) MIN

$\dfrac{0.060\ (1,52)}{0.015\ (0,38)}$

0.200 (5,08) MAX

Seating Plane

0.130 (3,30) MIN

A

$\dfrac{0.026\ (0,66)}{0.014\ (0,36)}$

0.100 (2,54)

0°−15°

$\dfrac{0.014\ (0,36)}{0.008\ (0,20)}$

4040083/F 03/03

NOTES: A. All linear dimensions are in inches (millimeters).
          B. This drawing is subject to change without notice.
          C. This package is hermetically sealed with a ceramic lid using glass frit.
          D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
          E. Falls within MIL STD 1835 GDIP1−T14, GDIP1−T16, GDIP1−T18 and GDIP1−T20.

DB (R-PDSO-G**)   **PLASTIC SMALL-OUTLINE**

28 PINS SHOWN

PINS ** DIM	14	16	20	24	28	30	38
A MAX	6,50	6,50	7,50	8,50	10,50	10,50	12,90
A MIN	5,90	5,90	6,90	7,90	9,90	9,90	12,30

4040065 /E 12/01

NOTES: A. All linear dimensions are in millimeters.
        B. This drawing is subject to change without notice.
        C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
        D. Falls within JEDEC MO-150

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